IN THE TITLE:

The title has been amended herein. Pursuant to 37 C.F.R. §§ 1.121 and 1.125 (as amended to date), please enter the title as amended.

AN INTERMEDIATE STRUCTURE HAVING <u>A</u>SILICON NITRIDE BARRIER LAYER <u>EMCAPSULATED THE ENCAPSULATING A</u>SEMICONDUCTOR SUBSTRATE

IN THE SPECIFICATION:

Pursuant to 37 C.F.R. §§ 1.121 and 1.125 (as amended to date) please enter the substitute specification in clean form and including paragraph numbers [0001] through [0034] and Abstract attached hereto as Appendix A. A marked-up substitute specification to clearly identify amendments to the specification as required by 37 C.F.R. § 1.121(b)(3)(iii) is attached hereto as Appendix B. Paragraph numbering has been inserted and format changes have been made in order to more fully comply with current Patent Office practice. It is respectfully submitted that the substitute specification does not introduce new matter into the above-referenced patent application.